



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. 10/622,346 Confirmation No. 4811
First Inventor Sirinorakul Filing Date 07/19/2003
Tech. Center/ 2811 Examiner Douglas W. Owens
Art Unit
Title: Semiconductor Package Including Leadframe Roughened Using
Chemical Etchant To Prevent Separation Between Leadframe
And Molding Compound
Docket No.: NSE006 US Customer No.: 34036

Santa Clara, California
July 20, 2005

MAIL STOP RCE
COMMISSIONER FOR PATENTS
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Dear Sir:

In response to Office Action dated May 23, 2005, please amend the above-identified application as follows.

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks/Arguments begin on page 7 of this paper.